# 505114219 09/27/2018

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
WEN-YUN WU	08/25/2015
JING-YING YUE	08/25/2015
XIAO-YANG LIN	08/25/2015
QING-YU ZHAO	08/25/2015
KAI-LI JIANG	08/25/2015
SHOU-SHAN FAN	08/25/2015

# **RECEIVING PARTY DATA**

Name:	Tsinghua University	
Street Address:	: No.1,Qinghua Yuan,Haidian District	
City:	Beijing	
State/Country:	CHINA	
	ne: HON HAI PRECISION INDUSTRY CO., LTD.	
Name:	HON HAI PRECISION INDUSTRY CO., LTD.	
Name: Street Address:	HON HAI PRECISION INDUSTRY CO., LTD.  66, Chung Shan Road, Tu-Cheng Dist.	
	,	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	16143510	

# **CORRESPONDENCE DATA**

**Fax Number:** (213)426-1788

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ATTORNEY DOCKET NUMBER:	US74685
NAME OF SUBMITTER:	CALVIN H CHAI

PATENT 505114219 REEL: 046986 FRAME: 0838

SIGNATURE: /Calvin H Chai/	
DATE SIGNED:	09/27/2018
Total Attachments: 3	

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PATENT REEL: 046986 FRAME: 0839

#### ASSIGNMENT

1.	WEN-YUN WU	, residing at	Beijing, China
2.	JING-YING YUE	, residing at	Beijing, China
3.	XIAO-YANG LIN	 , residing at	Beijing, China
4.	QING-YU ZHAO	 , residing at	Beijing, China
5.	KAI-LI JIANG	, residing at	Beijing, China
6.	SHOU-SHAN FAN	, residing at	Beijing, China
7.		, residing at	

(hereinafter collectively referred to as the "Assignor"), WITNESSETH:

WHEREAS, said Assignor has invented certain new and useful improvements in a:

# METHOD AND DEVICE FOR IMAGING 1-D NANOMATERIALS

set forth in an application for Letters Patent of the United States,

x   being executed concurrently hereinwith; or			
[ ] filed on	with U.S. Serial No.		
WHEREAS.			

TSINGHUA UNIVERSITY a corporation duly and lawfully organized, and having a principal place of business at: No.1, Qinghua Yuan, Haidian District, Beijing City, P.R.C.

HON HAI PRECISION INDUSTRY CO., LTD. a corporation duly and lawfully organized, and having a principal place of business at: 66,Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C. and

(hereinafter collectively referred to as the "Assignee"),

is desirous of acquiring the entire right, title and interest in and to said inventions and applications for Letters Patent of the United States, and in and to any Letters Patent or Patents, United States or foreign, to be obtained therefore and

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thereon:

NOW, THEREFORE, in consideration of one Dollar (\$1.00 USD) and other good and sufficient considerations, the receipt of which is hereby acknowledged, said Assignor has sold, assigned, transferred and set over, and by these presents does sell, assign, transfer and set over, unto said Assignee, its successors, legal representatives and assigns, Assignor's interest in the entire right, title and interest in and to the abovementioned inventions, application for Letters Patent, and any and all Letters Patent or Patents in the United States of America and all foreign countries which may be granted therefore and thereon, and in and to any and all divisions, continuations, and continuations-in-part of said application, or reissues or extensions of said Letters Patent or Patents, and all rights under the International Convention for the Protection of Industrial Property, the same to be held and enjoyed by said Assignee, for its own use and behalf and the use and behalf of its successors, legal representatives and assigns, to the full end of the term or terms for which Letters Patent or Patents may be granted, as fully and entirely as the same would have been held and enjoyed by the Assignor, had this sale and assignment not been made;

AND for the same consideration, said Assignor hereby covenants and agrees to and with said Assignee, its successors, legal representatives and assigns, that, at the time of execution and delivery of these presents, said Assignor is the lawful owner of the entire right, title and interest in and to said invention and the application for Letters Patent above mentioned, and that the same is unencumbered and that said Assignor has good and full right and lawful authority to sell and convey the same in the manner herein set forth;

AND for the same consideration, said Assignor hereby covenants and agrees to and with said Assignee, its successors, legal representatives and assigns, that said Assignor will, whenever counsel of said Assignee, or the counsel of its successors, legal representatives and assigns, shall advise that any proceeding in connection with said inventions, or said application for Letters Patent, or any proceeding in connection with Letters Patent for said inventions in any country, including interference proceedings, is lawful and desirable, or that any division, continuation or continuation-in-part of any application for Letters Patent, or any reissue or extension of any Letters Patent, to be obtained thereon, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary or required to be done for the procurement, maintenance, enforcement and defense of Letters Patent for said inventions, without charge to said Assignee, its successors, legal representatives and assigns, but at the cost and expense of said Assignee, its successors, legal representatives and assigns;

ASSIGNOR(S) does/do hereby authorize ASSIGNEE or its patent agents or attorneys to insert, above, the jurisdictions, application numbers, filing dates and any other indicia identifying the Applications when such information is available for the purpose of recording this assignment.

1.	WEN-YUN WU	Aug.25,2015  Date
2.	JING-YING YUE	Aug.25,2015
	JING-YING YUE	Date
3.	X1AO-YANG LIN	Aug.25,2015
	XIAO-YANG LIN	Date
4.	QING-YU ZHAO	Aug.25,2015
	QING-YU ZHAO	Date
5.	(Qin)	Aug.25,2015
	KAI-LI JIANG	Date
6.	elph yar	Aug.25,2015
	SHOU-SHAN FAN	Date
7.		Date

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